

DATASHEET

4 PIN DIP PHOTOTRANSISTOR PHOTOCOUPLER EL817 Series



Features:

- Compliance Halogens Free (Only copper leadframe) (Br < 900 ppm, Cl < 900 ppm, Br+Cl < 1500 ppm)
- Current transfer ratio

(CTR: $50\sim600\%$ at IF = 5mA, VcE = 5V)

- High isolation voltage between input and output (Viso = 5000Vrms)
- Creepage distance > 7.62mm
- Operating temperature up to +110°C
- · Compact small outline package
- •The product itself will remain within RoHS compliant version
- Compliance with EU REACH
- UL and cUL approved(No.E214129)
- VDE approved (No. 132249)
- SEMKO approved
- NEMKO approved
- DEMKO approved
- FIMKO approved
- CQC approved

Description

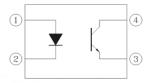
The EL817 series of devices each consist of an infrared emitting diodes, optically coupled to a phototransistor detector.

They are packaged in a 4-pin DIP package and available in wide-lead spacing and SMD option.

Applications

- Programmable controllers
- · System appliances, measuring instruments
- Telecommunication equipments
- Home appliances, such as fan heaters, etc.
- Signal transmission between circuits of different potentials and impedances

Schematic



Pin Configuration

- 1. Anode
- 2. Cathode
- 3. Emitter
- 4. Collector



Absolute Maximum Ratings (Ta=25℃)

Parameter	Symbol	Rating	Unit
Forward current	I_{F}	60	mA
Peak forward current (1us, pulse)	I _{FP}	1	A
Reverse voltage	V _R	6	V
Power dissipation	D	100	mW
Derating factor (above T _a = 100°C)	P_{D}	2.9	mW/°C
Power dissipation	_	150	mW
Derating factor (above T _a = 100°C)	PC	5.8	mW/°C
Collector current	I _C	50	mA
Collector-Emitter voltage	V_{CEO}	35	V
Emitter-Collector voltage	V_{ECO}	6	V
Dissipation	P _{TOT}	200	mW
age* ¹	V _{ISO}	5000	V rms
mperature	T _{OPR}	-55 to 110	℃
perature	T _{STG}	-55 to 125	°C
mperature* ²	T _{SOL}	260	℃
	Forward current Peak forward current (1us, pulse) Reverse voltage Power dissipation Derating factor (above T _a = 100°C) Power dissipation Derating factor (above T _a = 100°C) Collector current Collector-Emitter voltage Emitter-Collector voltage Dissipation age*1 mperature	Forward current I_F Peak forward current (1us, pulse) I_{FP} Reverse voltage V_R Power dissipation P_D Power dissipation P_D Power dissipation P_D Power dissipation P_C Collector (above P_D P_C Collector current P_C Collector-Emitter voltage P_C Emitter-Collector voltage P_C Dissipation P_T age*1 P_T Topa	Forward current I_F 60 Peak forward current (1us, pulse) I_{FP} 1 Reverse voltage V_R 6 Power dissipation Derating factor (above T_a = 100°C) P_D 150 Power dissipation Derating factor (above T_a = 100°C) P_C 5.8 Collector current I_C 50 Collector-Emitter voltage I_C 35 Emitter-Collector voltage I_C 6 Dissipation I_C 500 Topa 55 to 110 Power dissipation I_C 500 Topa 55 to 125

Notes:

^{*1} AC for 1 minute, R.H.= $40 \sim 60\%$ R.H. In this test, pins 1, 2 are shorted together, and pins 3, 4 are shorted together.

^{*2} For 10 seconds



Electro-Optical Characteristics (Ta=25°C unless specified otherwise)

Input

Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition
Forward Voltage	V_{F}	-	1.2	1.4	V	I _F = 20mA
Reverse Current	I _R	-	-	10	μA	V _R = 4V
Input capacitance	C _{in}	-	30	250	pF	V = 0, f = 1kHz

Output

Parameter	Symbol	Min	Тур.	Max.	Unit	Condition
Collector-Emitter dark	lana	_	_	100	nA	$V_{CE} = 20V, I_{F} = 0mA$
current	ICEO		_	100	ПА	V CE - 20 V, IF - OIIIA
Collector-Emitter	BV_CEO	35	_	_	V	$I_{\rm C} = 0.1 \text{mA}$
breakdown voltage	DACEO	33	_	_	v	IC - 0. IIIIA
Emitter-Collector	BV_{ECO}	6			V	I _E = 0.1mA
breakdown voltage		O	-	-		

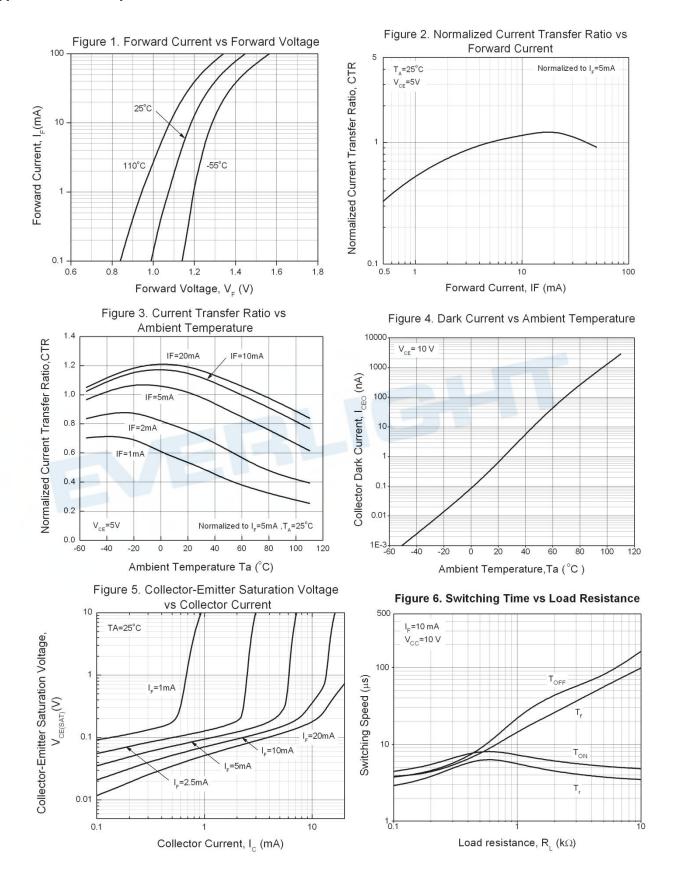
Transfer Characteristics

Para	meter	Symbol	Min	Тур.	Max.	Unit	Condition
	EL817	Æ	50		600		I _F = 5mA ,V _{CE} = 5V
	EL817A		80	-	160	- - - % -	
Current	EL817B		130	-	260		
Transfer	EL817C	CTR	200	-	400		
ratio	EL817D		300	-	600		
	EL817X		100	-	200		
	EL817Y		150	-	300		
Collector-E saturation		$V_{\text{CE(sat)}}$	-	0.1	0.2	V	I _F = 20mA ,I _C = 1mA
Isolation re	esistance	R _{IO}	5×10 ¹⁰	-	-	Ω	V _{IO} = 500Vdc, 40~60% R.H.
Floating ca	apacitance	C_{IO}	-	0.6	1.0	рF	$V_{IO} = 0$, $f = 1MHz$
Cut-off free	quency	fc	-	80	-	kHz	$V_{CE} = 5V, I_{C} = 2mA$ $R_{L} = 100\Omega, -3dB$
Rise time		t_{r}	-	-	18	μs	$V_{CE} = 2V$, $I_C = 2mA$,
Fall time		t _f	-	-	18	μs	$R_L = 100\Omega$

^{*} Typical values at T_a = 25°C



Typical Electro-Optical Characteristics Curves





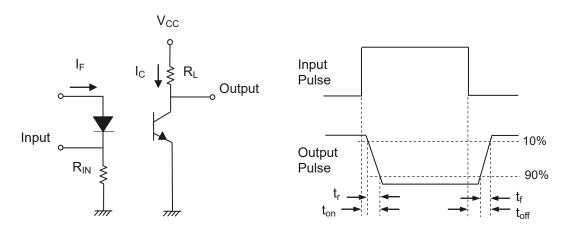


Figure 7. Switching Time Test Circuit & Waveforms





Order Information

Part Number

EL817X(Y)(Z)-FV

Note

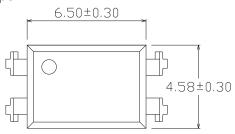
X = Lead form option (S1, S2, M or none)
 Y = CTR Rank (A, B, C, D, X, Y or none)
 Z = Tape and reel option (TU, TD or none)
 F = Lead frame option (F: Iron, None: copper)
 V = VDE safety (optional)

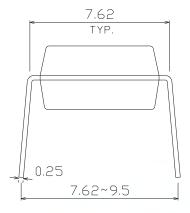
Option	Description	Packing quantity
None	Standard DIP-4	100 units per tube
М	Wide lead bend (0.4 inch spacing)	100 units per tube
S1 (TU)	Surface mount lead form (low profile) + TU tape & reel option	1500 units per reel
S1 (TD)	Surface mount lead form (low profile) + TD tape & reel option	1500 units per reel
S2 (TU)	Surface mount lead form (low profile) + TU tape & reel option	2000 units per reel
S2 (TD)	Surface mount lead form (low profile) + TD tape & reel option	2000 units per reel

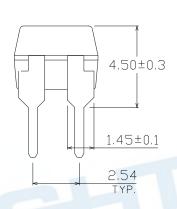


Package Dimension (Dimensions in mm)

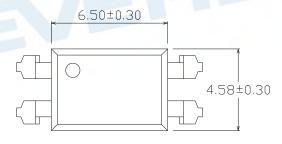
Standard DIP Type

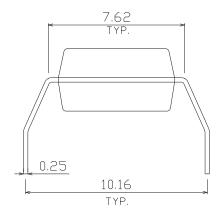


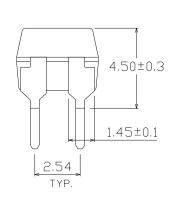




Option M Type

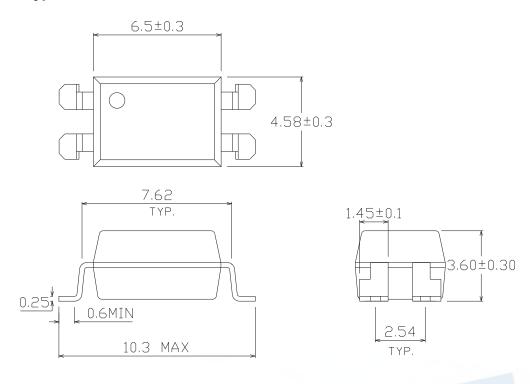




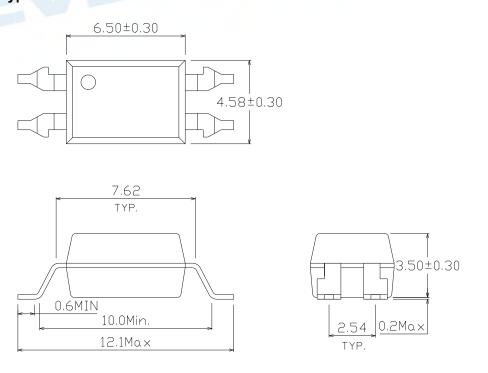




Option S1 Type

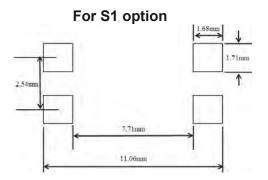


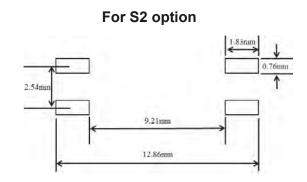
Option S2 Type





Recommended pad layout for surface mount leadform





Notes

Suggested pad dimension is just for reference only. Please modify the pad dimension based on individual need.





Device Marking



Notes

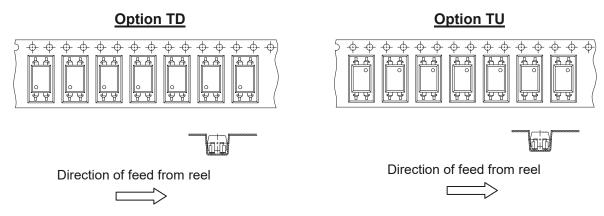
EL	denotes EVERLIGHT
817	denotes Device Number

F denotes Factory Code (G: China and Green part) R denotes CTR Rank (A, B, C, D, X, Y or none)

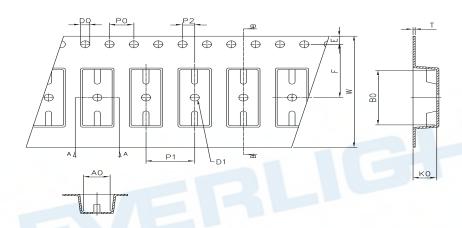
Y denotes 1 digit Year code WW denotes 2 digit Week code V denotes VDE (optional)



Tape & Reel Packing Specifications



Tape dimensions



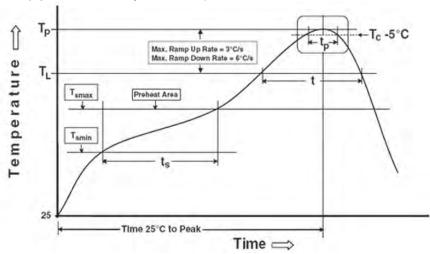
Dimension No.	Ao	Во	Do	D1	E	F
Dimension (mm) S1	4.90±0.1	10.40±0.1	1.5±0.1	1.50±0.1	1.75±0.1	7.50±0.1
Dimension (mm) S2	4.88±0.1	12.55±0.1	1.5±0.1	1.50±0.1	1.75±0.1	11.5±0.1
Dimension No.	Ро	P1	P2	t	w	Ко
Dimension (mm) S1	4.00±0.1	8.00±0.1	2.00±0.1	0.40±0.1	16.00±0.3	4.60±0.1
Dimension (mm) S2	4.00±0.1	8.00±0.1	2.00±0.1	0.40±0.1	24.00±0.3	4.00±0.1



Precautions for Use

1. Soldering Condition

1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note: Reference: IPC/JEDEC J-STD-020D

Preheat

Temperature min (T_{smin}) 150 °C

Temperature max (T_{smax}) 200 °C

Time (Tsmin to Tsmax) (ts) 60-120 seconds

Average ramp-up rate (Tsmax to Tp) 3 °C/second max

Other

Liquidus Temperature (T_L) 217 °C Time above Liquidus Temperature (t_L) 60-100 sec

Peak Temperature (T_P) 260°C

Time within 5 °C of Actual Peak Temperature: T_P - 5°C 30 s

Ramp- Down Rate from Peak Temperature 6°C /second max.

Time 25°C to peak temperature 8 minutes max.

Reflow times 3 times



DISCLAIMER

- 1. Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
- 2. The graphs shown in this datasheet are representing typical data only and do not show guaranteed values.
- 3. When using this product, please observe the absolute maximum ratings and the instructions for use outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
- 4. These specification sheets include materials protected under copyright of EVERLIGHT. Reproduction in any form is prohibited without the specific consent of EVERLIGHT.
- 5. This product is not intended to be used for military, aircraft, automotive, medical, life sustaining or life saving applications or any other application which can result in human injury or death. Please contact authorized Everlight sales agent for special application request.
- 6. Statements regarding the suitability of products for certain types of applications are based on Everlight's knowledge of typical requirements that are often placed on Everlight products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Everlight's terms and conditions of purchase, including but not limited to the warranty expressed therein.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Transistor Output Optocouplers category:

Click to view products by Everlight manufacturer:

Other Similar products are found below:

LTV-814S-TA LTV-824HS 66095-001 6N136-X017T MCT6-X007 MOC8101-X017T PS2561A-1-W-A PS2561B-1-L-A PS2561L-1-V-A MRF658 IL755-1X007 ILD74-X001 ILQ615-2X017 ILQ615-3X016 LDA102S LDA110S SFH615AGR-X007T PS2561-1-V-W-A PS2561AL-1-V-A PS2561L1-1-L-A PS2562-1-V-A PS2581L2-A PS2701A-1-F3-P-A PS2801-1-F3-P-A PS2911-1-L-AX CNY17-2X017 CNY17-4X001 CNY17-4X001 CNY17-4X017 CNY17F-1X007 CNY17F-2X017 CNY17F-4X001 CNY17G-1 LTV-702VB LTV-733S LTV-816S-TA LTV-825S TCET1113 TCET2100 4N25-X007T IL215AT ILD2SMTR ILD615-1X007 ILQ2-X007 VO217AT VOS615A-2T WPPC-A11066AA WPPC-A11066AD WPPC-A11084ASS WPPC-A21068AA WPPC-D11066AA